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Docket 0553-0393

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In Re Application of:

Shunpei Yamazaki et al.

Serial No.: 10/757,167

Filed: January 13, 2004

For: Method For Manufacturing Conductive Layer)  
And Semiconductor Device )

I hereby certify that this correspondence  
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Cristie M. Hall

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Date: August 3, 2004

SUBMISSION OF NEW DECLARATION AND ASSIGNMENT

Applicants submitted a declaration and assignment with the filing of the application. Unfortunately, there was a typographical error in the title in both documents. Accordingly, Applicants are submitting herewith a new declaration and assignment with the correct title. The undersigned authorizes the Commissioner to charge our deposit account 50/1039 for any fee due for this submission.

Respectfully submitted,

Mark J. Murphy  
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